



# Data Sheet

Customer:	
Part No:	CL-SFC518IR-1050,1150,1250-05
Sample No:	
Description:	5050 SMD IR SENSOR
Item No:	

Customer					
Check	Inspection	Approval	Date		







### **Aatures**

- Long operating life
- Highest flux
- Wide range of colors:2500K-25000K
- Lambertian radiation pattern
- More energy efficient than incandescent

and most halogen lamps

- Low voltage DC operated
- Cool beam, safe to the touch
- Instant light (less than 100ns)
- Fully dimmable
- No UV
- Superior ESD protection
- Eutectic die band
- RoHS compliant

# **Applications**

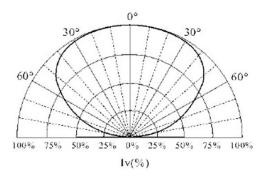
- Reading lights (car, bus, aircraft)
- LCD Backlights/light Guides
- Fiber optic alternative/ Decorative / Entertainment
- Mini-accent/Up lighters/Down lighters/ Orientation
- Indoor/Outdoor commercial and Residential Architectural
- Cove/Under shelf/Task
- Bollards/Security/Garden
- Portable (flashlight, bicycle)
- Edge-lit signs (Exit, point of sale)
- Automotive Exit (Stop-Tail-Turn,CHMSL,

Mirror Side Repeat)

Traffic signaling / Beacons / RailCrossing

and Wayside

## Radiation Pattern



1150

1250

1350

nm

nm

nm

°C/W





#### Typical Optical/ Electrical Characteristics @TJ=25°C Symbol Condition Min. Typ. Max. Unit Forward Voltage IR $V_{\mathsf{F}}$ IF=60mA 1.0 1.5 V IR Forward Voltage $V_F$ IF=60mA 0.9 1.4 V Forward Voltage IR $V_F$ IF=60mA 8.0 1.3 ٧ Reverse Current VR=5v 5 μΑ 201/2 // 50% Power Angle --120 deg IR IF=60mA Luminous Intensity ф۷ 5 10 mw Luminous Intensity IR ф٧ IF=60mA 5 10 mw Luminous Intensity ф٧ IF=60mA 4 9 mw $^{\circ}$ C Junction temperature $T_{\rm J}$ // --125 IR IF=60mA

IF=60mA

IF=60mA

//

1050

1150

1250

8

Notes:1.Tolerance of measurement of forward voltage±0.1V.

IR

IR

2. Tolerance of measurement of peak Wavelength±2.0nm.

Tc

Tc

Тс

 $R_{JP}$ 

3. Tolerance of measurement of luminous intensity ±5%.

## Absolute Maximum Rating

Resistance, Junction to Case

Dominant wavelength

Dominant wavelength

Dominant wavelength

Thermal

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	IF	60	mA
Peak Forward Current*	IFP	100	mA
Reverse Voltage	VR	5	V
Power Dissipation	PD	0.2	W
Operation Temperature	TOPR	-40~+80	$^{\circ}$
Storage Temperature	TSTG	-40~+100	$^{\circ}$ C
Lead Soldering	TSOL	Max. 260°C for 5sec Max.	
Temperature*			

<sup>\*</sup>IFP Conditions: Pulse Width≤10msec duty≤1/10

<sup>\*</sup> All high power emitter LED products mounted on aluminum metal-core printed circuit board, can be lighted directly, but we do not recommend lighting the high power products for more than 5 seconds without a appropriate heat dissipation equipment.

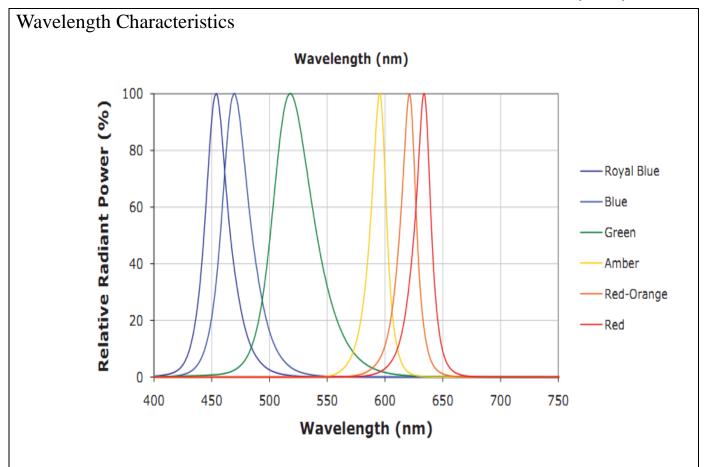
<sup>\*</sup>Re-flow, wave peak and soak-stannum soldering etc. is not suitable for this products.

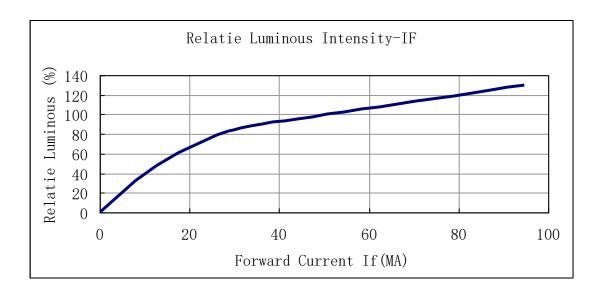
<sup>\*</sup>Suggest to solder it by professional high power LED soldering machine.

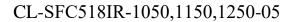
<sup>\*</sup>Can use invariable-temperatur e searing-iron with soldering condition :≤260 degree less than 3 seconds.





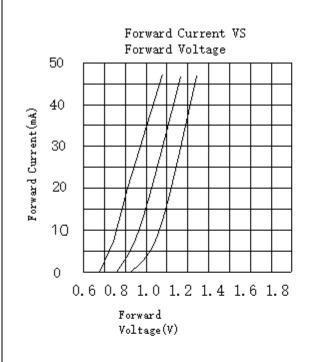


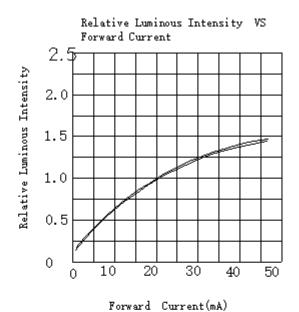


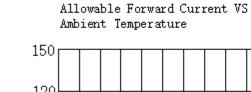


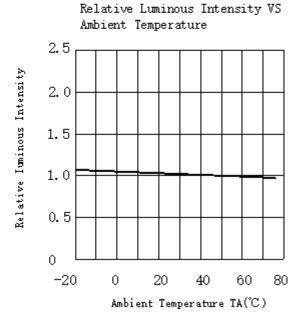


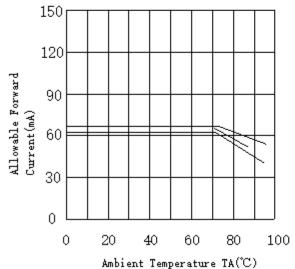










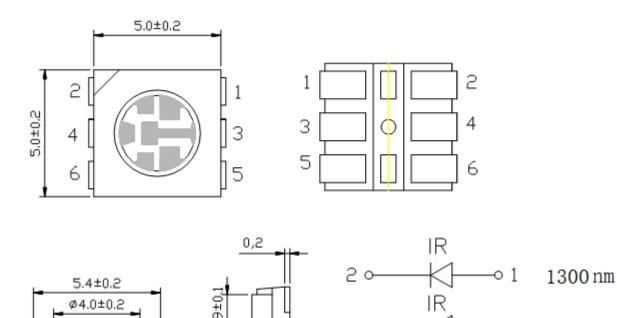


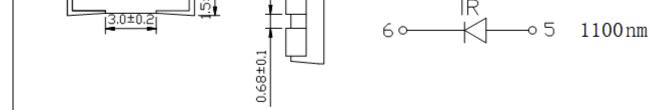
1200 nm





### **Package Dimensions**

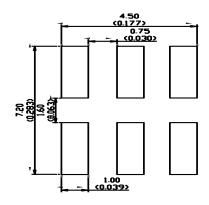




Notes: 1. All dimension units are millimeters.

- 2. All dimension tolerance is ±0.2mm unless otherwise noted.
- 3. The brass column of heat sink of the high power LED is Anode. Please pay more attention to the necessary installation, when installing The heat dissipate on equipments and connecting the electric circuit in avoid of short circuit and destroying

### Recommended Soldering Patter:







# Package Adhesive Pipe (units:mm) Note:

- LED bracket forming method: The pin of LED canbe bent where is at least 2mm out of LED colloid; Finishing the forming of LED bracket must be before soldering; Guarantee the gap between two pin of LED tallys with LED pads in PCB when forming;
- 2 Manual soldering: The tip temperature of soldering iron don't exceed 300 °C; soldering time don't exceed 3s and soldering position must be 3mm out of led colloid;
- 3 Static electricity and high volt can damage LED, The production whose Die material is InGaN must strictly required ESD, Must put on static glove and static fillet, soldering tool and the cover of device must connect the ground, soldering condition follows the related stating of production specification manual.
- 4 Protecting countermeasure when over current: Need add the protecting resistor in circuit in order to avoid damaging led due to big current and voltage fluctuation
- 5 LED installation method: LED can be stored for a year under the condition, the temperture of  $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$  and humidity of RH60%, These production must be re-inspected and tested before use if their storage time exceed a year.
- If LED is exposed in air for a week under the condition, the temperature of 5  $^{\circ}$ C  $^{\circ}$ 35  $^{\circ}$ C, humidity of RH60%, must place the LED in the ambience of 65  $^{\circ}$ C  $^{\circ}$ 5  $^{\circ}$ C for 24 hours.

